Bath temperature impact on morphological evolution of Ni(OH)$_2$ thin films and their supercapacitive behaviour

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Abstract. Nanostructured Ni(OH)$_2$ thin films were deposited over stainless steel (SS) and glass substrate via simple chemical bath deposition (CBD) method. NiCl$_2$:6H$_2$O were used as source of nickel and aqueous ammonia as a complexing agent. The coating process of Ni(OH)$_2$ material over substrate is based on the decomposition of ammonia complexed nickel ions at two different bath temperatures. The changes in structural, morphological and electrochemical properties are examined as an impact of bath temperature. XRD studies reveal formation of mixed phase of $\alpha$ and $\beta$ at lower bath temperature (313 K) while, pure $\beta$ phase of Ni(OH)$_2$ thin films deposited was observed at higher bath temperature (353 K). The morphological evolution from honeycomb structure to vertically aligned flakes over the substrate is observed as the influence of bath temperature. The supercapacitive performance based on the morphology examined by using cyclic voltammetric measurements in 1 M KOH. The maximum specific capacitances of 610 and 460 F/g were observed for the vertical flake and honeycomb structured Ni(OH)$_2$ thin films, respectively.

Keywords. Ni(OH)$_2$; chemical bath deposition; structural analysis; surface morphology; supercapacitive behaviour.

1. Introduction

Electrochemical capacitors (supercapacitor) are being paid attention as an energy storage device due to its high power density, high charge/discharge cycle life and high energy efficiency (Largeot et al 2008; Wang et al 2012). So due to such extensive electrochemical properties, supercapacitor can be used in such a device, which requires high energy in a very short time. On the basis of storage mechanism, there are two types of supercapacitor, electrical double-layer (EDLC) and redox (pseudo capacitance) supercapacitors (Kandalkar et al 2010). The charge storage in double-layer supercapacitors is achieved by the formation of a double layer on the surface of the electrode material, whereas in redox supercapacitors, charge is stored on both the electrode surfaces through bulk of the material via Faradaic reaction. Therefore, charge stored in redox supercapacitors is greater than double-layer counterparts (Kandalkar et al 2010).

Subsequently, the pseudocapacitance comes mainly from the reversible redox reactions of the electro-active materials and conducting polymers and transition metal oxides/hydroxides are considered as promising material for redox supercapacitors (Cai et al 2004). Large surface area is an essential criterion to achieve larger capacitance. So many researchers find it interesting to develop different nanostructures of redox material in such a manner as it can offer large surface area and large pore volume for easy access to redox electrolyte (Matsui et al 2002; Yang et al 2004).

Nanostructured nickel hydroxide [Ni(OH)$_2$], one of the most important transition metal hydroxides, has received increasing attention due to its extensive applications, especially as a positive electrode active material, in alkaline rechargeable Ni-based batteries. Besides, it is well known that the crystallographic state, morphology and chemical composition of Ni(OH)$_2$ material are key parameters, which determine the electrochemical behaviour. Ni(OH)$_2$ with different nanostructures has been fabricated, such as tubes (Coudun and Hochepied 2005) and rods (Wang et al 2005) by template synthesis, nanoribbon by hydrothermal method (Liang et al 2004), stacks of pancakes by a chemical method (Chen and Gao 2005), hollow spheres by a simple solution chemistry method and sheet-like geometry by the hydrothermal method (Liu et al 2005; Ni et al 2005; Wu et al 2006).

However, one-step simple fabrication of Ni(OH)$_2$ active material with high surface area remains a considerable challenge. To optimize functional properties of the nanostructures for electrochemical applications, self-assembly method has been crucial. However, full knowledge and precise control of the self-assemble process are still difficult. The surface engineering research and industrial applications need

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low-cost processing methods for large-scale production of materials with necessary performance and engineered surface. One such method, which is simple, low cost and applicable for large-scale production is chemical bath deposition (CBD) which has its own advantages such as simplicity, reproducibility, non-hazardous, cost effectiveness, etc (Mane and Lokhande 2000; Pawar et al 2011). Thus, CBD method has been preferred over other expensive methods (Cao et al 2007). In order to improve physical and electrochemical performance of devices, manufacturing Ni(OH)₂ morphology is the focus of current research.

In the present work, we synthesized Ni(OH)₂ thin films at two different bath temperatures (313 and 353 K) from an alkaline nickel chloride solution by adopting ammonia as complexing agent for complexion with good controllability and reproducibility. Subsequently effect of bath temperature on physicochemical characteristics such as structural, morphological and electrochemical properties of material was systematically studied. In addition, we have proposed schematic model for the evolution of microstructure as an effect of bath temperature on growth and distribution of Ni(OH)₂ onto substrate in thin film form.

2. Experimental

The nanocrystalline Ni(OH)₂ thin films have been deposited by CBD method at different bath temperatures lower (313 K) and higher (353 K), on glass and stainless steel substrates. The source of Ni used was 0·1 M Ni(Cl)₂·6H₂O and to make it alkaline, aqueous ammonia was added. Primarily precipitate of Ni(OH)₂ occurs which gets dissolved after further addition of aqueous ammonia. The resultant pH of solution was ~12. The stainless steel cleaned by fine polish paper (0·5 grade) and glass microslides were washed with detergent, followed by rinsing with double-distilled water and finally treated with ultrasonic waves for 15 min. These cleaned substrates were immersed in the prepared bath. When the bath attained the desired temperature, precipitation was started in the bath. During precipitation, heterogeneous reaction occurred over substrate surface and growth of Ni(OH)₂ took place. The substrates coated with Ni(OH)₂ thin films were taken out from the bath, dried in air and preserved in an airtight plastic container before examining the properties.

The thickness of nickel hydroxide film was measured by the weight difference method using a sensitive microbalance. Structural identification of nickel hydroxide films was carried out with X-ray diffractometer (XRD) (copper target (λ=1·54056 Å)). The microstructures of films were examined with a scanning electron microscope (SEM) (JEOL–JAPAN 6360). Electrochemical analysis of the films deposited on steel substrates was studied by cyclic voltammetry (CV) using a potentiostat (263A EG&G, Princeton Applied Research Potentiostat). The electrochemical cell comprises of a platinum counter electrode, saturated calomel, a reference electrode (SCE) and Ni(OH)₂, working electrode immersed in 1 M KOH electrolyte. All potentials are recorded and reported with respect to SCE.

3. Results and discussion

3.1 Film formation mechanism

Thin film formation in CBD method was observed when the solution attains supersaturated state (Hodes 2002). At supersaturated condition ionic product exceeds solubility product of the metal hydroxide, precipitation occurs and ions combine on the substrate to form nuclei. Further film growth can take place by ion-by-ion condensation of materials or by adsorption of colloidal particles from the solution on the substrate (Lokhande et al 2005; Shinde et al 2007). Nickel hydroxide thin films have been deposited on steel substrates by slow hydrolysis of nickel chloride solution. This can be represented by as follows.

First, nickel chloride (NiCl₂·6H₂O) was complexed with ammonia (NH₃), a white precipitate of Ni(OH)₂ appears first, according to the reaction:

\[
\text{Ni}^{2+} + 2\text{OH}^- \rightarrow \text{Ni(OH)}_2. \quad (1)
\]

Further addition of NH₃ solution, Ni(OH)₂ precipitate redissolved into the solution, reaction leading into the formation of soluble Ni(NH)₃⁺⁺ complex

\[
\text{Ni(OH)}_2 + 4\text{NH}_3 \rightarrow \text{Ni(NH)}_3^{2+} + 2\text{OH}^- . \quad (2)
\]

As bath temperature and deposition time prolongs, Ni²⁺ ions slowly dissociates from Ni(NH)₃⁺⁺ complex and reacts with OH⁻ ions, to form Ni(OH)₂:

\[
\text{Ni(NH)}_3^{2+} + 2\text{OH}^- \rightarrow \text{Ni(OH)}_2 + 4\text{NH}_3. \quad (3)
\]

Bath temperature directly determines the decomposition rate of ammonia metal ion complex and changes nucleation rate and growth rates of nanocrystals. On the basis of bath temperature effect, growth rate of materials in thin film form with respect to deposition time is shown in figure 1. The film thickness is measured in terms of weight deposited on
3.2 Structural analysis

X-ray diffraction study was carried out for the determination of crystal structure along with structural changes and identification of phases of prepared Ni(OH)₂ thin films. Figure 2 shows XRD patterns of polycrystalline Ni(OH)₂, for samples N1 deposited at 313 and N2 deposited at 353 K, respectively. XRD pattern of sample N1 shows formation of mixed α and β phases of Ni(OH)₂ at lower temperature (313 K) while pure β phase was observed at higher temperature (353 K) (JCPDS card nos. 01-1047 and 74-2075 Yang et al. 2007). Two factors are important in transformation of phase α–β of Ni(OH)₂, viz., the expulsion of intercalative water and ions (i.e. Cl⁻) in α phase and adjustment of the stacking orders of Ni(OH)₂ layers. In earlier reports, the phase transformation α–β Ni(OH)₂ can be easily performed in the presence of alkali through chemical aging (Bernard et al. 1996). The high reaction temperature favours transformation process above and provides driving force and energy to restructure the stacking order of Ni(OH)₂ layers. Thus, low temperature allows the formation of mixed (α and β) phases of Ni(OH)₂ and high temperature favours the formation of β Ni(OH)₂ (Tong et al. 2012).

3.3 Surface morphology

The morphological change as an impact of bath temperature was studied by using SEM images. SEM micrographs of a ‘Ni(OH)₂’ thin film prepared at different bath temperatures are presented in figure 3(a). The morphology of Ni(OH)₂ prepared at low bath temperature (313 K) is shown in figures 3(a, b). The film is porous and well covered with overgrown particles on the substrate. The surface morphology at higher magnification (figure 3(b)) is seen to be a well-covered, interconnected, macroporous, honeycomb-like structure. However, figures 3(c and d) shows SEM image of Ni(OH)₂ thin film prepared at high bath temperature (353 K). Figure 3(c) shows formation of microflowers comprising of vertical nanoflakes. SEM image at higher magnification shown in figure 3(d) reveals that flakes are vertically grown on substrate surface. The morphology reveals a mesoporous structure. The flake and honeycomb-like morphologies lead to a high specific surface area and porous volume, which provide the structural foundation for the high specific capacitance (Patil et al. 2009; Gurav et al. 2010).

Schematic growth model for bath temperature influenced by Ni(OH)₂ thin films is shown in figure 3(b) which supports growth kinetics for morphology alteration. Chemical bath deposition is one of the well known ‘bottom-up’ approaches based on the formation of a solid phase upon transformation of a supersaturated solution to the saturated state. This transformation incorporated with various distinct steps such as nucleation, coalescence and subsequent growth by aggregation of the particles. During nucleation, clusters of metal precursor molecules are likely to undergo rapid decomposition. Such nucleation centres acted as foundation for aggregation of the particles. Moreover, basic groundwork for the nanostructure is formed by coalescence of aggregated particles. Reaction bath temperature is a strategic factor that affects on structural and chemical properties of the Ni(OH)₂ product. The growth kinetic is slow at lower temperature, 313 K, so one-dimensional (1 D) growth of nanospecies takes place which leads to the formation of honeycomb morphology. However, rise in bath temperature results in the increase in reaction rate, so Ni(OH)₂ grains grown rapidly, which leads to the formation of flake-like morphology (2 D) comprising bunch of microflakes. Such change in growth kinetics at higher bath temperature is due to breaking rate of complexed metal ions which release more metal ions for rapid nucleation and the growth process resulted in the formation of 2 D flakes. The morphology evolution of Ni(OH)₂ as influence of bath temperature is due to nanodomains getting squeezed together into bunch of microflakes to form flower-
Figure 3. (a) SEM images of nickel hydroxide prepared at (a, b) 313 and (c, d) 353 K bath temperatures. (b) Schematic diagram of growth model for nickel hydroxide thin films prepared at different bath temperatures.
like microstructure. Pawar et al (2010) also reported bath temperature effect onto morphology of ZnO, altered from fibrous flakes into rod-like microstructure.

### 3.4 Supercapacitive behaviour of Ni(OH)$_2$ thin film

The distinctive morphology plays a basic role in supercapacitor, it provides easy accessibility to electrolyte OH$^-$ ions to Ni(OH)$_2$ active material and a fast diffusion rate within the redox phase. It is believed that the unique morphological foundation is one of the key parameters to improve specific capacitance (Yan et al 2012). Therefore, CBD deposited different nanostructured Ni(OH)$_2$ electrodes were used in the supercapacitor and their performance were tested using cyclic voltammetry (CV), charge–discharge curve and electrochemical impedance analysis (EIS). The supercapacitive study was carried out by means of effect of scan rate on specific capacitance. The specific capacitance (F/g) of the electrode was obtained by dividing the capacitance to weight dipped in the electrolyte.

Figure 4 shows CV curves of Ni(OH)$_2$ thin films. The redox couple from CV indicates that the capacitance characteristic of electrode is different from that of electric double-layer capacitance, which is normally close to an ideal rectangular shape. This outcome suggests that the capacitance of Ni(OH)$_2$ mainly results from a pseudo-capacitive behaviour. There were two clear redox peaks P1 and P2 in CV curves. The anodic peak P1 was due to the oxidation of Ni(OH)$_2$ to NiOOH and the cathodic peak P2 was for the reverse process. The oxidation and reduction peaks are at different potentials for samples N1 (figure 4(a)) and N2 (figure 4(b)). These differences in reduction and oxidation potentials for both samples are due to thin film containing different phases of Ni(OH)$_2$ material. For (α and β) mixed phase electrode N1, the oxidation peak observed at 0·4V/SCE and reduction peak at 0·25 V/SCE, such oxidation and reduction processes at lower potentials are attributed to the presence of α phase of Ni(OH)$_2$ in the film (Lang et al 2010). However, figure 4(b) shows CV curves of sample N2, it reveals oxidation potential at 0·48 V/SCE and reduction potential at close to 0·35 V/SCE. Similar redox potentials were reported for β-Ni(OH)$_2$ (Patil et al 2009), this result confirms that sample N2 contains pure β phase of Ni(OH)$_2$. The appearance of anodic and cathodic peaks corresponding to the Ni(OH)$_2$/NiOOH redox reaction in CV is according to the following electrochemical reaction:

$$\text{Ni(OH)}_2 + \text{OH}^- \leftrightarrow \text{NiOOH} + \text{H}_2\text{O} + e^- \quad (4)$$

As an effect of scan rate, shown in figure 4(a), interestingly shifting of oxidation and reduction peaks for N1 sample is observed. Moreover, currents of all scan rates for Ni(OH)$_2$ electrodes increased rapidly at the positive sweep potential range. When the scan rate increased, the anodic peak P1 almost disappeared. Such change in oxidation may be due to the unstable nature of α phase Ni(OH)$_2$ (Chen and Gao 2005). Because, the electrode cannot bear the higher scan rate. At high scan rate, ions on the electrode are depleted rapidly with increasing current, while ions in the electrolyte solution diffuse too slowly to satisfy the need for ions near the interface during the charging and discharging process (Gujar et al 2007).

Figure 5 shows variation of specific capacitance with respect to scan rate. The graph shows a maximum achieved specific capacitance of about 610 F/g for sample N2 at lowest scan rate, 2 mV/s. Whereas, a maximum specific capacitance of up to 460 F/g at a scan rate 2 mV/s is seen in sample N1. However, sample N1 shows a stable capacitance at higher scan rate as compared to sample N2. It is mainly because of the distinctive surface morphology of sample N1. Generally, at higher scan rate, capacitance decreases drastically because of inner active sites which cannot sustain the redox transitions completely at higher scan rates. This is probably due to the diffusion effect of charges within the electrode. The decreasing capacitance suggests that parts of the surface of the electrode are inaccessible at high charging–discharging
Figure 5. Plots of variation of specific capacitance with scan rate for samples (N1) 313 and (N2) 353 K.

Figure 6. Charge–discharge curves of nickel hydroxide thin films for samples (N1) 313 and (N2) 353 K at 0.5 mA/cm² rates (Gujar et al. 2007). Honeycomb-like morphology of sample N1 can provide large surface area for easy accessibility of ions from electrolyte; it resulted in good sustainability of electrode at higher scan rate.

Figure 6 shows charge-discharge curves of samples N1 and N2. Charge/discharge galvanostatic plot measured at 0.5 mA/cm² is shown in figure 6. The observed nonlinearity in charge–discharge profile, which deviates from the typical linear variation of voltage with time, normally exhibited by EDLCs, can be explained as due to the pseudo-capacitance arising out of the redox reaction at this voltage range (Li et al. 2012). At the beginning of charge and discharge, a sharp change in voltage (∆V1) is due to the equivalent series resistance (ESR) of the electrochemical capacitor cell. The calculated ESR for N1 and N2 samples are 60 and 160 Ω/cm², respectively. Such high ESR calculated from charge–discharge restricts to achieve maximum value of specific capacitance close to theoretical one.

The electrochemical impedance studies (EIS) (in frequency 10^5–10^−2 Hz) of Ni(OH)₂ is carried out in 1 M KOH. The complex-plane plot shown in figure 7 consists of a small semicircle at higher frequencies with a transition to a linear part at low frequencies which corresponds to a capacitive behaviour (Lufrano and Staiti 2010). The electronic resistance is related to the intrinsic electronic resistance of Ni(OH)₂ particles and the interfacial resistances of particles-to-particles and particles-to-current collector. An impedance arc of a semicircle is visible in the high frequency region (≥1000 Hz), which can be attributed to the complicated interfaces at Ni(OH)₂ particles and Ni(OH)₂–substrate contacts, since electron hopping at these interfaces occurs during the charge/discharge processes. At low-frequencies, an approximately vertical increase in Z” appeared, demonstrating typical capacitive characteristics, which should be governed by the Faradaic reactions of Ni(OH)₂ between different oxidation states. From the Nyquist plot one can observe solution resistance (Rₛ) value is higher for sample N1 as compared with sample N2 (13 > 9Ω) (Adekunle et al. 2011). The charge transfer resistance (Rₜ) is also smaller for sample N2 than the sample N1 (125 < 180 Ω), these results obtained may be due to small electrochemical distribution resistance (EDR) exerted by macroporous structure of honeycomb like morphology (Yang et al. 2012). Small Rₛ and EDR values of sample N2 than N1 are imperative for high supercapacitance of sample N2. This result predicts that the charges can easily transfer towards electrode through the vertically grown microflakes instead of honeycomb structure. The results obtained from EIS study gives detailed information of maximum specific capacitance for sample N2 than N1.

4. Conclusions
In summary, different nanostructured Ni(OH)₂ thin films were prepared by using chemical bath deposition (CBD)
method at different bath temperatures. It is concluded that the bath temperature strongly influence the structural and morphological properties of Ni(OH)$_2$ thin films. The mixed phases of $\alpha$ and $\beta$ were prepared at lower bath temperature (N1), however, pure $\beta$ phase of Ni(OH)$_2$ (N2) were prepared at higher bath temperature. The films deposited at low temperature (N1) showed interconnected honeycomb structure while films deposited at higher temperature (N2) shows well-developed flake-like morphology. Crystal structure and morphology influences on electrochemical performance of the electrode. EIS studies showed, vertical flake-like morphology is good in supercapacitor application in terms of small charge transfer resistance ($R_{ct}$) than honeycomb-like morphology. Vertical nanoflakes and its porous structure can provide easy charge transportation through material with stress-free accommodation for ions from electrolyte. Vertically aligned flakes with porous structure showed maximum specific capacitance of 610 F/g.

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